

## HNMe<sub>2</sub> Inhibits the Reaction of Ti(NMe<sub>2</sub>)<sub>4</sub> with NH<sub>3</sub>: Implications for the Chemical Vapor Deposition of TiN and Related Nitrides

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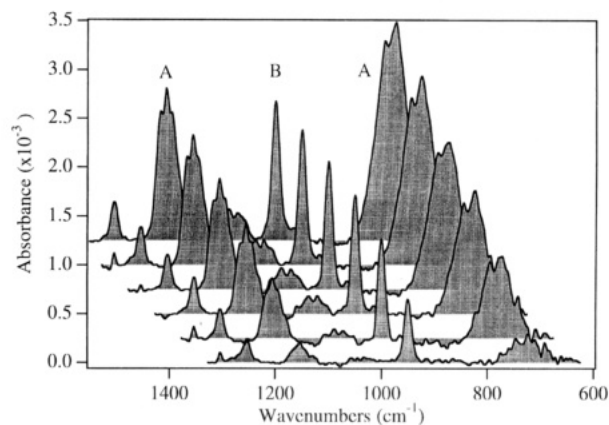
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The chemical vapor deposition (CVD) of TiN diffusion barriers for metalization is critical to future generations of integrated circuits.<sup>1</sup> As the feature size of integrated circuits becomes smaller than 0.5 μm, one of the only techniques that gives good step coverage on these high aspect ratio features is CVD. Currently there are two viable CVD processes for TiN: TiCl<sub>4</sub> + NH<sub>3</sub><sup>2</sup> and Ti(NR<sub>2</sub>)<sub>4</sub> (R = Me, Et) + NH<sub>3</sub>.<sup>3</sup> The TiCl<sub>4</sub> process gives TiN with excellent step coverage, but the temperature is too high for integrated circuits and Cl contamination is a problem. Ti(NR<sub>2</sub>)<sub>4</sub> + NH<sub>3</sub> gives good step coverage at low temperature with no Cl contamination. As a result, there has been intense recent interest in this CVD system.<sup>3–7</sup>

Gas phase chemical reactions play an important role in TiN CVD from Ti(NR<sub>2</sub>)<sub>4</sub> and NH<sub>3</sub>. NH<sub>3</sub> is required to produce low-carbon, low-resistivity films. Gas-phase transamination to produce HNR<sub>2</sub> was demonstrated and apparently serves to remove carbon from the precursor in situ.<sup>7</sup> Although the higher vapor pressure of Ti(NMe<sub>2</sub>)<sub>4</sub> makes it more desirable as a starting material, the resulting step coverage is insufficient for integrated circuit applications. Ti(NEt<sub>2</sub>)<sub>4</sub> gives much better step coverage, but its low vapor pressure is problematic.<sup>5</sup> Using a flow tube reactor, we have measured the gas-phase kinetics of Ti(NMe<sub>2</sub>)<sub>4</sub> + NH<sub>3</sub> and found the rate constant at 24 °C to be large for these stable molecules,  $k = (1.2 \pm 0.2) \times 10^{-16} \text{ cm}^3 \text{ molecule}^{-1} \text{ s}^{-1}$  ( $3.8 \pm 0.6 \text{ Torr}^{-1} \text{ s}^{-1}$ ).<sup>8</sup> The rate constant for Ti(NEt<sub>2</sub>)<sub>4</sub> is much smaller<sup>9</sup> and this apparently leads to better step coverage. The gas-phase reaction of Ti(NMe<sub>2</sub>)<sub>4</sub> is fast and



**Figure 1.** IR spectra of the reaction of Ti(NMe<sub>2</sub>)<sub>4</sub> with NH<sub>3</sub> as a function of added HNMe<sub>2</sub>. The peak labeled B is for Ti(NMe<sub>2</sub>)<sub>4</sub>, and the peaks labeled A are for HNMe<sub>2</sub>. The HNMe<sub>2</sub> pressure increases from front to rear (0, 0.051, 0.098, 0.148, 0.198, 0.248, 0.297 Torr) the NH<sub>3</sub> pressure is constant at 0.46 Torr, and the reaction time is 0.60 s. Each spectrum is offset by  $2.5 \times 10^{-4}$  absorbance units and  $25 \text{ cm}^{-1}$ .

probably results in the formation of intermediates with high sticking coefficients or low surface mobility.<sup>10</sup> This work shows that the gas-phase reaction of Ti(NMe<sub>2</sub>)<sub>4</sub> with NH<sub>3</sub> is strongly inhibited by HNMe<sub>2</sub>. This result has important implications for the mechanism of the reaction. Furthermore, it points to the use of amines to control the reaction of amido compounds with NH<sub>3</sub> to improve the properties of TiN and other nitride materials.

The technique used for these measurements is a flow tube reactor interfaced to an FTIR spectrometer described previously.<sup>8,11</sup> Separate flows of Ti(NMe<sub>2</sub>)<sub>4</sub> and NH<sub>3</sub> were mixed in a 1-m-long, Teflon-coated, stainless steel tube via a sliding injector. Reactants and products were monitored downstream, and the reaction time is controlled by the variable distance between the injector and the focused IR beam at a constant flow velocity. Mass flow meters measured the separate gas flows of buffer (He), bubbler (He), window purge (Ar), NH<sub>3</sub> (9.77% in He), and HNMe<sub>2</sub> (16.8% in He). The total pressure was 10.0 Torr, and the temperature was  $24 \pm 1 \text{ }^\circ\text{C}$ . The gas flow was held constant by compensating changes in NH<sub>3</sub> or HNMe<sub>2</sub> flow with buffer gas. The spectrometer was operated at  $8 \text{ cm}^{-1}$  resolution, and 256 scans were averaged. Reference spectra of NH<sub>3</sub> were subtracted from the data to remove overlapping bands.

Figure 1 shows the IR spectra when Ti(NMe<sub>2</sub>)<sub>4</sub> is reacted with NH<sub>3</sub> in the presence of HNMe<sub>2</sub>. The injector position was held at 30 cm and the flow velocity was  $49.7 \text{ cm s}^{-1}$  for a reaction time of 0.60 s. Holding the total gas flow and the NH<sub>3</sub> pressure constant (0.46 Torr), the partial pressure of HNMe<sub>2</sub> was varied (0, 0.051, 0.098, 0.148, 0.198, 0.248, 0.297 Torr). The band labeled B at  $950 \text{ cm}^{-1}$  is the NC<sub>2</sub> stretch for Ti(NMe<sub>2</sub>)<sub>4</sub>,<sup>12</sup>

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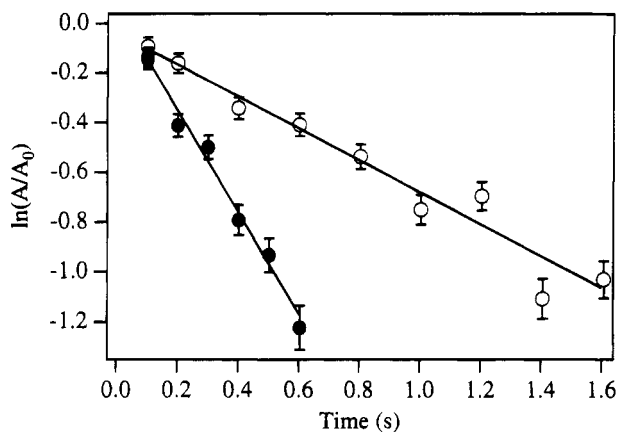
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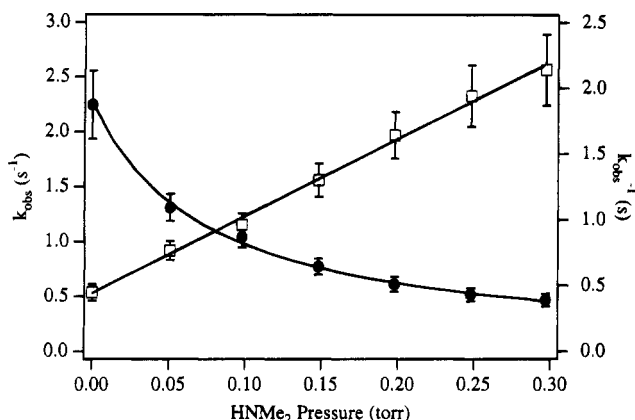
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**Figure 2.** Effect of HNMe<sub>2</sub> on the reaction rate of Ti(NMe<sub>2</sub>)<sub>4</sub> with NH<sub>3</sub>. The NH<sub>3</sub> pressure is 0.46 Torr. The slope is  $k_{\text{obs}}$ , and the open points are with added HNMe<sub>2</sub> (0.198 Torr), and the solid points are without HNMe<sub>2</sub>.

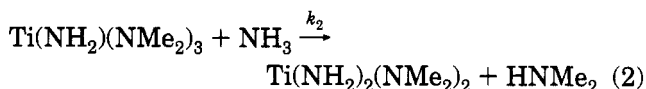
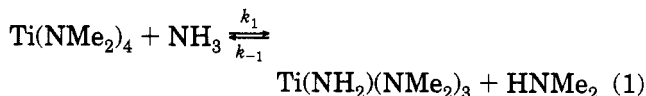


**Figure 3.** Dependence of  $k_{\text{obs}}$  on HNMe<sub>2</sub> pressure. Both  $k_{\text{obs}}$  (●) and  $(k_{\text{obs}})^{-1}$  (□) are shown. The NH<sub>3</sub> pressure is held constant at 0.46 Torr.

and the bands labeled A at 1156 and 730 cm<sup>-1</sup> are both for HNMe<sub>2</sub> (CH<sub>3</sub> rock and NH bend, respectively).<sup>13</sup> As the partial pressure of HNMe<sub>2</sub> is increased at constant NH<sub>3</sub> pressure, the amount of Ti(NMe<sub>2</sub>)<sub>4</sub> clearly *increases*. Addition of sufficient HNMe<sub>2</sub> to the gas stream almost completely inhibits the reaction of Ti(NMe<sub>2</sub>)<sub>4</sub> with NH<sub>3</sub> over this time scale.

Figure 2 shows the decay rates of Ti(NMe<sub>2</sub>)<sub>4</sub> under conditions of 0.46 Torr of NH<sub>3</sub> with and without added HNMe<sub>2</sub>. The data are plotted as  $\ln(A/A_0)$  vs  $t$  where  $A$  is the absorbance of Ti(NMe<sub>2</sub>)<sub>4</sub> at time  $t$ ,  $A_0$  is the absorbance of Ti(NMe<sub>2</sub>)<sub>4</sub> in the absence of NH<sub>3</sub>, and  $\ln(A/A_0) = -k_{\text{obs}}t$ . Both semilog plots are linear, indicating a simple first order decay for both conditions. The rate constant ( $k_1$ ) is calculated from the slope ( $k_{\text{obs}}$ ) and the NH<sub>3</sub> pressure where  $k_{\text{obs}} = k_1(\text{NH}_3)$ . In the absence of HNMe<sub>2</sub>, the rate constant is the same as that observed earlier,  $k_1 = (1.4 \pm 0.2) \times 10^{-16}$  cm<sup>3</sup> molecule<sup>-1</sup> s<sup>-1</sup>. In the presence of 0.198 Torr of HNMe<sub>2</sub>, the rate constant is reduced significantly to  $k_1 = (0.43 \pm 0.03) \times 10^{-16}$  cm<sup>3</sup> molecule<sup>-1</sup> s<sup>-1</sup>. Figure 3 shows that  $k_{\text{obs}}$  is inversely dependent on HNMe<sub>2</sub> concentration. Using data as in Figure 1,  $k_{\text{obs}}$  was calculated from  $\ln(A/A_0)$  and the reaction time. Also shown is a linear dependence of  $(k_{\text{obs}})^{-1}$  on HNMe<sub>2</sub>. HNMe<sub>2</sub> clearly inhibits the reaction of Ti(NMe<sub>2</sub>)<sub>4</sub> with NH<sub>3</sub>.

The mechanistic implication of Figures 1–3 is clear: the reaction between Ti(NMe<sub>2</sub>)<sub>4</sub> and NH<sub>3</sub> must be reversible. Bradley et al. showed that the transamination reactions between numerous amido compounds and amines are at equilibrium in solution.<sup>14</sup> Therefore it is reasonable to propose the first step in the mechanism as reversible transamination to form the transient intermediate Ti(NR<sub>2</sub>)<sub>3</sub>(NH<sub>2</sub>) as shown in (1). The subsequent reactions are of particular interest since they control which species reach the surface. Two reasonable possibilities are reaction with NH<sub>3</sub> in a second transamination step to form Ti(NH<sub>2</sub>)<sub>2</sub>(NMe<sub>2</sub>)<sub>2</sub> (2) or elimination of HNMe<sub>2</sub> to form an imido complex (3):



Using the steady-state approximation on Ti(NR<sub>2</sub>)<sub>3</sub>(NH<sub>2</sub>) for the two mechanisms (1)–(2) and (1)–(3), the respective expressions for  $k_{\text{obs}}$  are<sup>15</sup>

$$k_{\text{obs}} = \frac{k_1 k_2 (\text{NH}_3)^2}{k_{-1} (\text{HNMe}_2) + k_2 (\text{NH}_3)} \quad (4)$$

$$k_{\text{obs}} = \frac{k_1 k_3 (\text{NH}_3)}{k_{-1} (\text{HNMe}_2) + k_3} \quad (5)$$

With no added HNMe<sub>2</sub>, both expressions give the observed linear dependence of  $k_{\text{obs}}$  on NH<sub>3</sub>,  $k_{\text{obs}} = k_1(\text{NH}_3)$ , and the derived bimolecular rate constant represents the forward transamination reaction ( $k_1$ ). Both expressions also predict the observed linear dependence of  $(k_{\text{obs}})^{-1}$  on HNMe<sub>2</sub>. The key difference is the order with respect to NH<sub>3</sub> in the presence of excess HNMe<sub>2</sub>; (5) is first order, while (4) is second order. At the highest HNMe<sub>2</sub> pressure used (0.297 Torr), the dependence of  $k_{\text{obs}}$  on NH<sub>3</sub> from 0 to 0.5 Torr was linear with a zero intercept. While this is not conclusive, we favor the mechanism (1)–(3) for several additional reasons. Ti(=NH)(NMe<sub>2</sub>)<sub>2</sub> could easily give bridging imido complexes such as those previously postulated as intermediates in this system.<sup>5</sup> A similar imido complex has been isolated as an intermediate in TiN CVD from TiCl<sub>4</sub> and NH<sub>3</sub><sup>16</sup> and there are several other related examples as well.<sup>17</sup> Experiments are in progress to further elucidate the mechanism.

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These results are apparently the first to show that a transamination reaction between a metal amido compound and  $\text{NH}_3$  is reversible. This has important implications for the CVD of TiN from  $\text{Ti}(\text{NR}_2)_4$  precursors since the addition of amines to the gas flow may provide a simple method for controlling the extent of gas-phase reaction and therefore the properties of TiN. Furthermore, metal amido precursors are useful CVD precursors for numerous nitride materials,<sup>18</sup> and this result will provide others an important consideration in understanding and controlling the chemistry of these CVD systems as well. We are currently exploring the effect added amine has on the properties of TiN depos-

ited as well as the generality of this effect for the gas-phase reactions of other metal amido compounds with  $\text{NH}_3$ .

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